

**Product data sheet** 

### 1. General description

Ultrafast power diode in a 2-lead TO247 plastic package.

#### 2. Features and benefits

- · Fast switching and soft reverse recovery characteristics
- Low forward voltage drop
- Low leakage current
- Low reverse recovery current
- · Reduces switching losses in associated MOSFET or IGBT

### 3. Applications

- UPS
- EV Charger
- Welding Machine
- Air Conditioner

### 4. Quick reference data

| Table 1. Q  | uick reference data             |  |             |        |      |     |      |
|---|---------------------------------|--|-------------|--------|------|-----|------|
| Symbol  | Parameter                       | Conditions   |             | Values |      |     | Unit |
| Absolute  | maximum rating                  |  |             |        |      |     |      |
| $V_{\text{RRM}}$  | repetitive peak reverse voltage |  | 600         |        |      | V   |      |
| $I_{F(AV)}$   | average forward current         | δ = 0.5 ; square-wave pulse; T <sub>mb</sub> ≤ 129 °C;<br>Fig. 1; Fig. 2; Fig. 3   | 60          |        |      | A   |      |
| I <sub>FSM</sub> non-repetitive peak<br>forward current |                                 | $t_{\rm p}$ = 10 ms; $T_{\rm j(init)}$ = 25 °C; sine-wave pulse;<br>Fig. 4   | 600         |        |      | A   |      |
|   |                                 | $t_{\rm p}$ = 8.3 ms; $T_{j(\text{init})}$ = 25 °C; sine-wave pulse  | 660         |        |      | А   |      |
| Symbol  | Parameter                       | Conditions   | Min Typ Max |        | Unit |     |      |
| Static ch   | aracteristics                   |  |             |        |      |     |      |
| V <sub>F</sub>  | forward voltage                 | I <sub>F</sub> = 60 A; T <sub>j</sub> = 25 °C; <u>Fig. 6</u>   |             | -      | 1.55 | 2   | V    |
|   |                                 | I <sub>F</sub> = 60 A; T <sub>j</sub> = 150 °C; <u>Fig. 6</u>  |             | -      | 1.2  | 1.6 | V    |
| Dynamic   | characteristics                 |  |             |        |      |     |      |
| t <sub>rr</sub>   | reverse recovery time           | $I_F = 1 \text{ A}; V_R = 30 \text{ V}; \text{ d}I_F/\text{d}t = 50 \text{ A}/\mu\text{s};$<br>$T_j = 25 \text{ °C}; \text{ Fig. 7}$ |             | -      | -    | 55  | ns   |

# **5. Pinning information**

| Pin | Pinning infor<br>Symbol | Description                         | Simplified outline | Graphic symbol          |
|-----|-------------------------|-------------------------------------|--------------------|-------------------------|
| 1   | K                       | cathode                             |                    |                         |
| 2   | А                       | anode                               |                    | K <u>A</u><br>001aaa020 |
| mb  | mb                      | mounting base; connected to cathode |                    |                         |

# 6. Ordering information

| Table 3. Ordering information |              |                 |                       |                   |                           |                 |                    |  |
|-------------------------------|--------------|-----------------|-----------------------|-------------------|---------------------------|-----------------|--------------------|--|
|                               | Type number  | Package<br>name | Orderable part number | Packing<br>method | Small packing<br>quantity | Package version | Package issue date |  |
|                               | BYV60W-600PS | TO247-2L        | BYV60W-600PSQ         | Tube              | 30                        | SOD142          | 08-Aug-2019        |  |

### 7. Marking

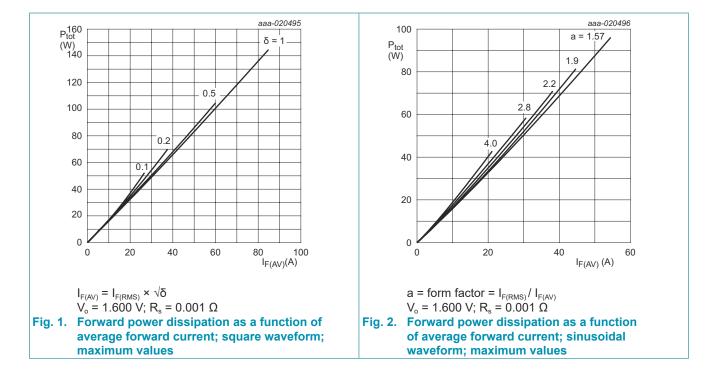
| Table 4. Marking codes |                 |
|------------------------|-----------------|
| Type number            | Marking codes   |
| BYV60W-600PS           | BYV60W<br>600PS |

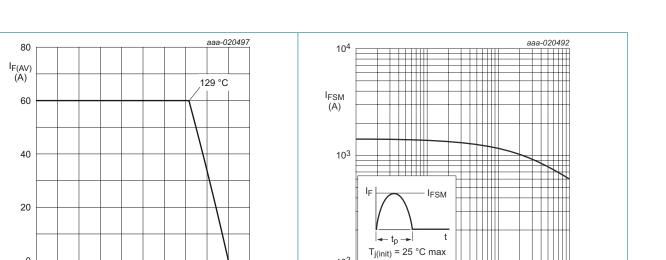
### 8. Limiting values

#### Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

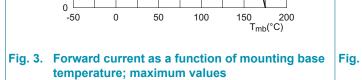
| Symbol             | Parameter                              | Conditions   | Values     | Unit |
|--------------------|--|--|------------|------|
| $V_{\text{RRM}}$   | repetitive peak reverse voltage        |  | 600        | V    |
| $V_{\text{RWM}}$   | crest working reverse voltage          |  | 600        | V    |
| V <sub>R</sub>     | reverse voltage                        | DC   | 600        | V    |
| I <sub>F(AV)</sub> | average forward current                | δ = 0.5 ; square-wave pulse; T <sub>mb</sub> ≤ 129 °C;<br>Fig. 1; Fig. 2; Fig. 3 | 60         | A    |
| I <sub>FRM</sub>   | repetitive peak forward current        | δ = 0.5; t <sub>p</sub> = 25 μs; T <sub>mb</sub> ≤ 129 °C;<br>square-wave pulse  | 120        | A    |
| I <sub>FSM</sub>   | non-repetitive peak<br>forward current | $t_p$ = 10 ms; $T_{j(init)}$ = 25 °C; sine-wave pulse;<br>Fig. 4                 | 600        | A    |
|                    |  | $t_p$ = 8.3 ms; $T_{j(init)}$ = 25 °C; sine-wave pulse                           | 660        | А    |
| T <sub>stg</sub>   | storage temperature                    |  | -55 to 175 | °C   |
| Tj                 | junction temperature                   |  | 175        | °C   |





10<sup>2</sup>

10<sup>-5</sup>





10<sup>-3</sup>

t<sub>p</sub> (s)

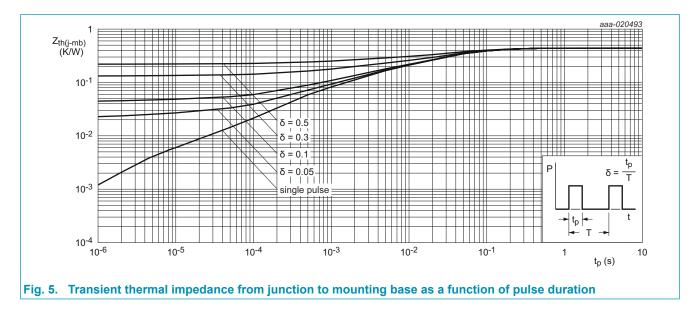
10<sup>-2</sup>

10-4

BYV60W-600PS Ultrafast power diode

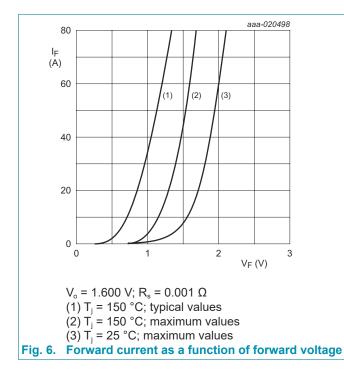
# 9. Thermal characteristics

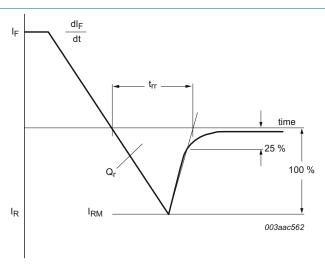
| Symbol                | Parameter  | Conditions                     | Min | Тур | Max  | Unit |
|-----------------------|--|--------------------------------|-----|-----|------|------|
| $R_{\text{th(j-mb)}}$ | thermal resistance<br>from junction to<br>mounting base    | with heatsink compound; Fig. 5 | -   | -   | 0.44 | K/W  |
| $R_{\text{th(j-a)}}$  | thermal resistance<br>from junction to<br>ambient free air | in free air                    | -   | 45  | -    | K/W  |



# **10. Characteristics**

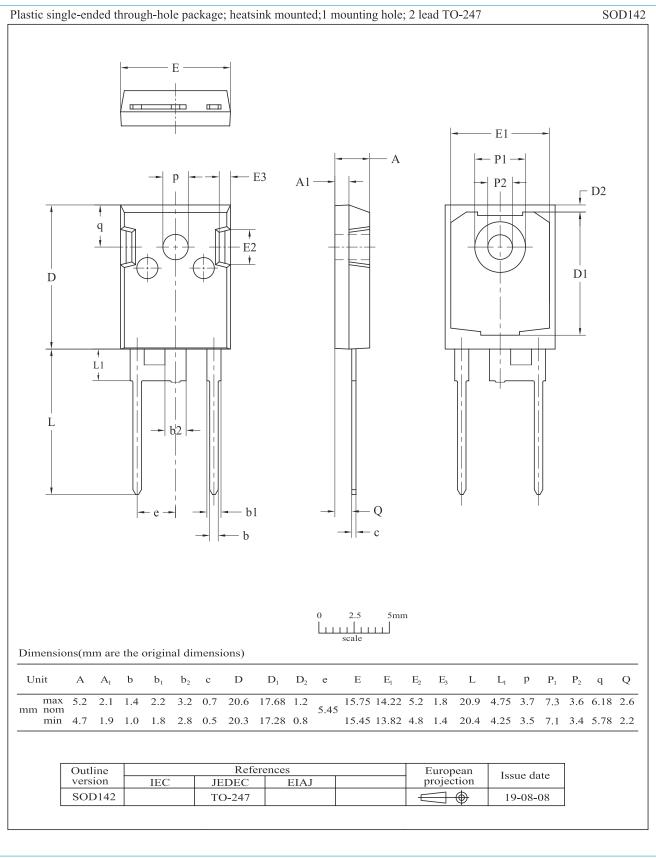
| Symbol          | Parameter                        | Conditions   |   | Тур  | Max | Unit |
|-----------------|----------------------------------|--|---|------|-----|------|
| Static ch       | aracteristics                    | · · · · · · · · · · · · · · · · · · ·  |   | -    |     | _    |
| V <sub>F</sub>  | forward current                  | I <sub>F</sub> = 60 A; T <sub>j</sub> = 25 °C; <u>Fig. 6</u>   | - | 1.55 | 2   | V    |
|                 |                                  | I <sub>F</sub> = 60 A; T <sub>j</sub> = 150 °C; <u>Fig. 6</u>  | - | 1.2  | 1.6 | V    |
| I <sub>R</sub>  | reverse current                  | V <sub>R</sub> = 600 V; T <sub>j</sub> = 25 °C   | - | -    | 10  | μA   |
|                 |                                  | V <sub>R</sub> = 600 V; T <sub>j</sub> = 125 °C  | - | -    | 500 | μA   |
| Dynamic         | characteristics                  | · · · · ·  |   |      |     | _    |
| t <sub>rr</sub> | reverse recovery time            | $I_F = 1 \text{ A}; V_R = 30 \text{ V}; dI_F/dt = 50 \text{ A}/\mu\text{s};$<br>$T_j = 25 \text{ °C}; Fig. 7$            | - | -    | 55  | ns   |
|                 |                                  | $I_F = 60 \text{ A}; V_R = 400 \text{ V}; dI_F/dt = 200 \text{ A}/\mu\text{s};$<br>$T_j = 25 \text{ °C}; Fig. 7$         | - | 53   | -   | ns   |
|                 |                                  | $I_F = 60 \text{ A}; V_R = 400 \text{ V}; dI_F/dt = 200 \text{ A}/\mu\text{s};$<br>$T_j = 125 \text{ °C}; Fig. 7$        | - | 120  | -   | ns   |
| I <sub>RM</sub> | peak reverse recovery<br>current | $I_F = 60 \text{ A}; V_R = 400 \text{ V}; dI_F/dt = 200 \text{ A}/\mu\text{s};$<br>$T_J = 25 \text{ °C}; Fig. 7$         | - | 5.4  | -   | A    |
|                 |                                  | $I_F = 60 \text{ A}; V_R = 400 \text{ V}; dI_F/dt = 200 \text{ A}/\mu\text{s};$<br>$T_j = 125 \text{ °C}; Fig. 7$        | - | 14.5 | -   | A    |
| Qr              | reverse charge                   | $I_F = 60 \text{ A}; V_R = 400 \text{ V}; dI_F/dt = 200 \text{ A}/\mu\text{s};$<br>$T_j = 25 \text{ °C}; Fig. 7$         | - | 143  | -   | nC   |
|                 |                                  | I <sub>F</sub> = 60 A; V <sub>R</sub> = 400 V; dI <sub>F</sub> /dt = 200 A/μs;<br>T <sub>i</sub> = 125 °C; <u>Fig. 7</u> | - | 876  | -   | nC   |







### 11. Package outline



# BYV60W-600PS

#### Ultrafast power diode

# 12. Legal information

#### Data sheet status

| Document status [1][2]               | Product<br>status [3] | Definition  |
|--------------------------------------|-----------------------|---|
| Objective<br>[short] data<br>sheet   | Development           | This document contains data from<br>the objective specification for product<br>development. |
| Preliminary<br>[short] data<br>sheet | Qualification         | This document contains data from the preliminary specification.                             |
| Product<br>[short] data<br>sheet     | Production            | This document contains the product specification.   |

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- [2] The term 'short data sheet' is explained in section "Definitions".
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